

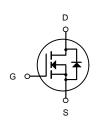
General Description

The BSC0805LSATMA1 use advanced SGT MOSFET technology to provide low RDS(ON), low gate charge, fast switching and excellent avalanche characteristics.

This device is specially designed to get better ruggedness.



DFN5X6-8L (Power(5x6))



N-Channel MOSFET

General Features

 V_{DS} =100V I_D =75A

 $R_{DS(ON)} < 7.5 m\Omega V_{GS} = 10 V$

Applications

Consumer electronic power supply Motor control

Synchronous-rectification Isolated DC

Synchronous-rectification applications

Package Marking and Ordering Information

Product ID	Pack	Brand	Qty(PCS)
BSC0805LSATMA1	DFN5X6-8L(Power(5x6))	HXY MOSFET	5000

Absolute Maximum Ratings at T_j=25°C unless otherwise noted

Parameter	Symbol	Value	Unit
Drain source voltage	VDS	100	V
Gate source voltage	VGS	±20	V
Continuous drain current ¹⁾	ID	75	Α
Pulsed drain current ²⁾	ID, pulse	300	Α
Power dissipation ³⁾	P _D	97	W
Single pulsed avalanche energy ⁵⁾	EAS	90	mJ
Operation and storage temperature	Tstg,Tj	-55 to 150	°C
Thermal resistance, junction-case	RθJC	1.3	°C/W

N-SGT Enhancement Mode MOSFET

Electrical Characteristics (T_J=25°C unless otherwise specified)

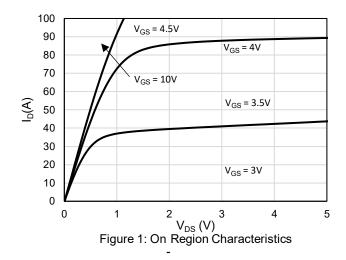
Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
Off Charac	cteristic					
V _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250μA	100	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =100V, V _{GS} =0V,	-	-	1.0	μA
I _{GSS}	Gate to Body Leakage Current	V _{DS} =0V, V _{GS} = ±20V	-	-	±100	nA
On Charac	cteristics			•		
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250μA	1.0	1.6	2.5	V
	Static Drain-Source on-Resistance	V _{GS} =10V, I _D =20A	-	6.4	7.5	mΩ
$R_{DS(on)}$	note3	V _{GS} =4.5V, I _D =8A		9.2	11.4	mΩ
Dynamic (Characteristics					
C _{iss}	Input Capacitance		-	2944	-	pF
Coss	Output Capacitance	V _{DS} =50V, V _{GS} =0V,	-	736	-	pF
C _{rss}	Reverse Transfer Capacitance	f=1.0MHz	-	2.04	-	pF
Qg	Total Gate Charge	\/ 50\/ L 00A	-	39.4	-	nc
Q _{gs}	Gate-Source Charge	V _{DS} =50V, I _D =30A, V _{GS} =10V	-	5.6	-	nc
Q_{gd}	Gate-Drain("Miller") Charge	VGS-10V	-	7.6	-	nc
Switching	Characteristics					
t _{d(on)}	Turn-on Delay Time		-	13	-	nc
t r	Turn-on Rise Time	V _{DD} =50V, I _D =25A,	_	27.5	-	nc
t _{d(off)}	Turn-off Delay Time	R _G =6Ω, V _{GS} =10V	-	45.5	-	nc
t _f	Turn-off Fall Time		-	41.5	-	nc
Drain-Sou	rce Diode Characteristics and Maxim	um Ratings				
Is	Maximum Continuous Drain to Source Diode Forward Current		-	-	75	Α
I _{SM}		Maximum Pulsed Drain to Source Diode Forward Current			300	Α
V _{SD}	Drain to Source Diode Forward Voltage	V _{GS} =0V, I _S =30A	-	-	1	V
t _{rr}	Body Diode Reverse Recovery Time	T =25°C	-	177	-	ns
Q _{rr}	Body Diode Reverse Recovery Charge	T _J =25°C, I _F =12A,dI/dt=100A/μs	-	1291	-	nc

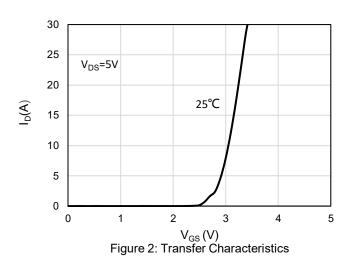
Notes:1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

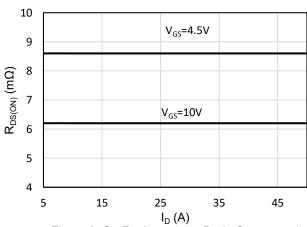
- 2. EAS condition: T_J =25°C, V_{DD} =50V, V_G =10V, R_G =25 Ω , L=0.5mH, I_{AS} =19A
- 3. Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%

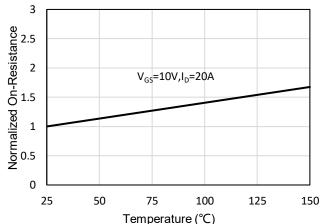


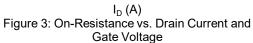
Typical Performance Characteristics

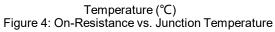


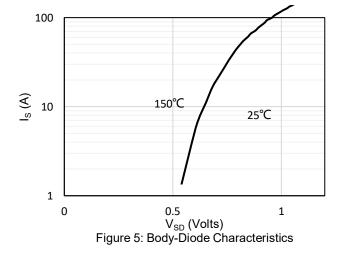


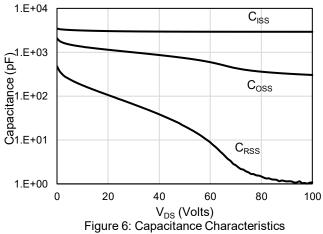




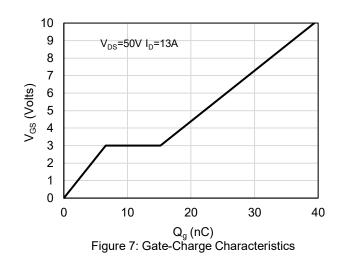


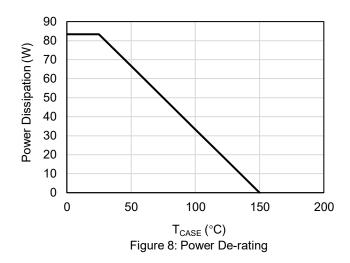


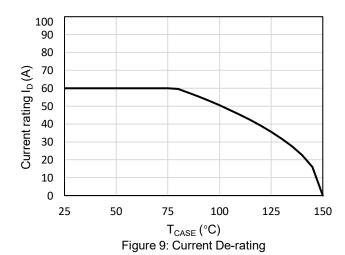


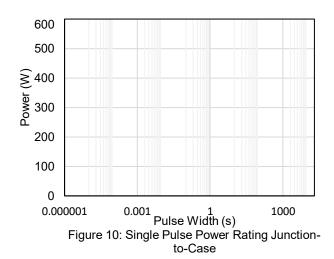


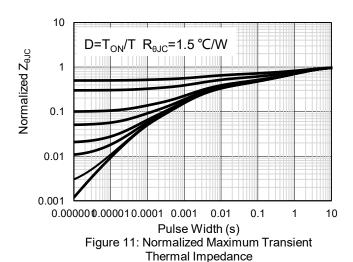












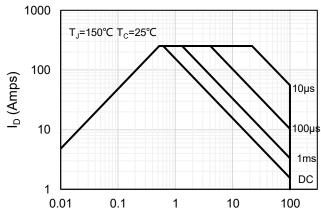
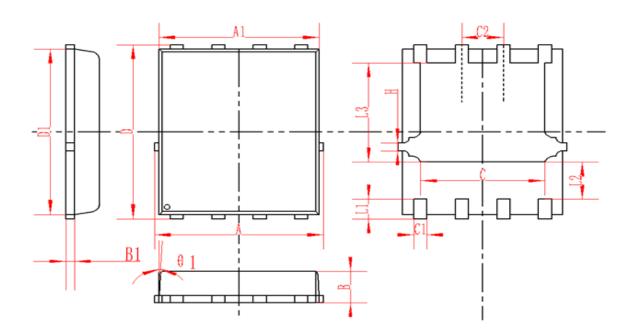


Figure 12: Maximum Forward Biased Safe Operating Area



DFN5X6-8L(Power(5x6)) Package Information



SYMBOL	MM		INCH			
STIVIDOL	MIN	NOM	MAX	MIN	NOM	MAX
А	4.95	5	5.05	0.195	0.197	0.199
A1	4.82	4.9	4.98	0.190	0.193	0.196
D	5.98	6	6.02	0.235	0.236	0.237
D1	5.67	5.75	5.83	0.223	0.226	0.230
В	0.9	0.95	1	0.035	0.037	0.039
B1	0.254REF		0.010REF			
С	3.95	4	4.05	0.156	0.157	0.159
C1	0.35	0.4	0.45	0.014	0.016	0.018
C2		1.27TYP			0.5TYP	
θ1	8°	10°	12°	8°	10°	12°
L1	0.63	0.64	0.65	0.025	0.025	0.026
L2	1.2	1.3	1.4	0.047	0.051	0.055
L3	3.415	3.42	3.425	0.134	0.135	0.135
Η	0.24	0.25	0.26	0.009	0.010	0.010



N-SGT Enhancement Mode MOSFET

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